LM2940QML 1A Low Dropout Regulator

Check for Samples: **LM2940QML**, **LM2940QML-SP**

FEATURES

- **Available with Radiation Ensure**
  - **ELDRS Free 100 krad(Si)**
- **Dropout Voltage Typically 0.5V @I_O = 1A**
- **Output Current in Excess of 1A**
- **Output Voltage Trimmed Before Assembly**
- **Reverse Battery Protection**
- **Internal Short Circuit Current Limit**
- **Mirror Image Insertion Protection**

DESCRIPTION

The LM2940 positive voltage regulator features the ability to source 1A of output current with a dropout voltage of typically 0.5V and a maximum of 1V over the entire temperature range. Furthermore, a quiescent current reduction circuit has been included which reduces the ground current when the differential between the input voltage and the output voltage exceeds approximately 3V. The quiescent current with 1A of output current and an input-output differential of 5V is therefore only 30 mA. Higher quiescent currents only exist when the regulator is in the dropout mode ($V_{IN} − V_{OUT} \leq 3V$).

Designed also for vehicular applications, the LM2940 and all regulated circuitry are protected from reverse battery installations or 2-battery jumps. During line transients, such as load dump when the input voltage can momentarily exceed the specified maximum operating voltage, the regulator will automatically shut down to protect both the internal circuits and the load. The LM2940 cannot be harmed by temporary mirror-image insertion. Familiar regulator features such as short circuit and thermal overload protection are also provided.
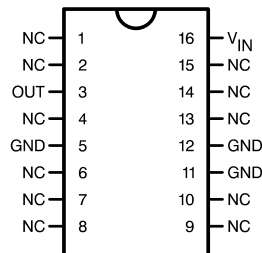
CONNECTION DIAGRAMS

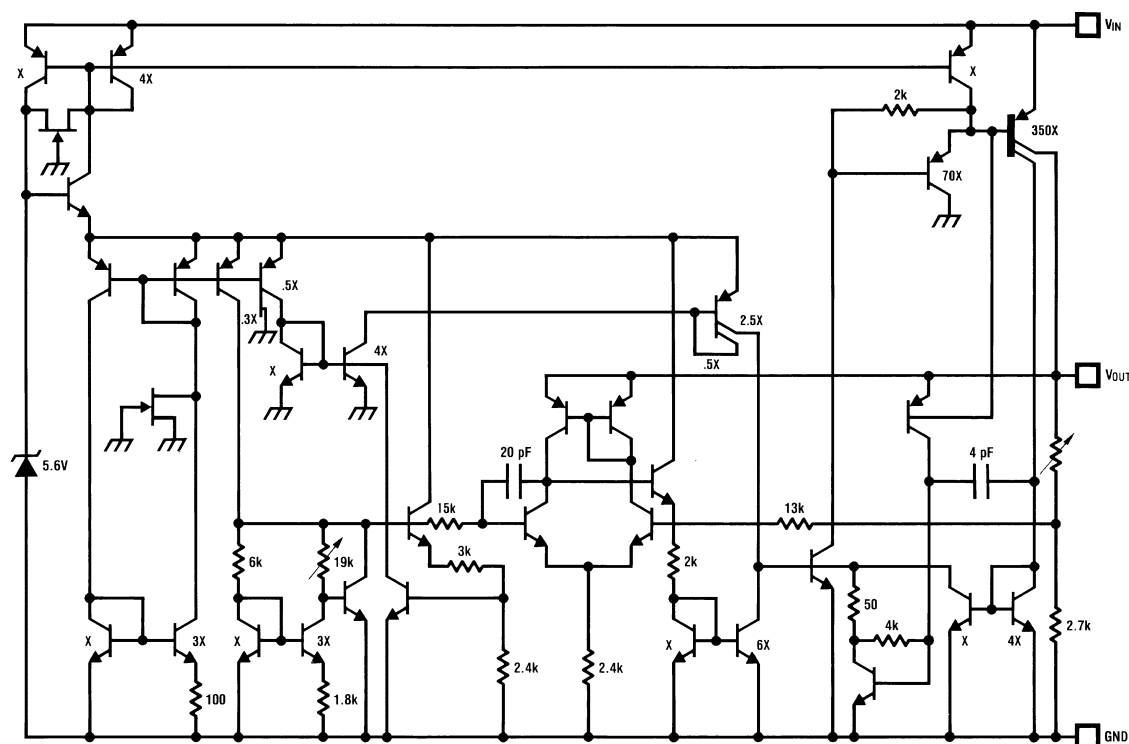**Figure 1. 16-Lead Ceramic Surface-Mount Package (CFP) Top View**

Equivalent Schematic Diagram

These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings[1]

Input Voltage (Survival Voltage ≤ 100mS)			60V
Internal Power Dissipation with no heat sink (T_A = +25°C)[2]			1W
Maximum Junction Temperature			150°C
Storage Temperature Range			−65°C ≤ T_A ≤ +150°C
Lead Temperature (Soldering 10 seconds)			300°C
Thermal Resistance	θ_{JA}	16LD CFP "WG" (device 01, 02) (Still Air)	122°C/W
		16LD CFP "GW" (device 03, 04) (Still Air)	136°C/W
		16LD CFP "WG" (device 01, 02) (500LF/Min Air flow)	77°C/W
		16LD CFP "GW" (device 03, 04) (500LF/Min Air flow)	87°C/W
	θ_{JC}	16LD CFP "WG" (device 01, 02)[3]	5°C/W
		16LD CFP "GW" (device 03, 04)	13°C/W
Package Weight CFP "WG" (device 01, 02)			360 mg
Package Weight CFP "GW" (device 03, 04)			410 mg
ESD Susceptibility[4]			4KV

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits. For specified specifications and test conditions, see the Electrical Characteristics. The ensured specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

(2) The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{Jmax} (maximum junction temperature), θ_{JA} (package junction to ambient thermal resistance), and T_A (ambient temperature). The maximum allowable power dissipation at any temperature is $P_{Dmax} = (T_{Jmax} - T_A)/\theta_{JA}$ or the number given in the Absolute Maximum Ratings, whichever is lower. With heat sinking, the maximum power is 5 Watts, but then this will depend upon the temperature of the heat sink, the efficiency of the heat sink, and the efficiency of the heat flow between the package body and the heat sink. We can not predict these values.

(3) The package material for these devices allows much improved heat transfer over our standard ceramic packages. In order to take full advantage of this improved heat transfer, heat sinking must be provided between the package base (directly beneath the die), and either metal traces on, or thermal vias through, the printed circuit board. Without this additional heat sinking, device power dissipation must be calculated using θ_{JA}, rather than θ_{JC}, thermal resistance. It must not be assumed that the device leads will provide substantial heat transfer out of the package, since the thermal resistance of the lead frame material is very poor, relative to the material of the package base. The stated θ_{JC} thermal resistance is for the package material only, and does not account for the additional thermal resistance between the package base and the printed circuit board. The user must determine the value of the additional thermal resistance and must combine this with the stated value for the package, to calculate the total allowed power dissipation for the device.

(4) Human body model, 1.5 kΩ in series with 100 pF.

Recommended Operating Conditions[1]

Input Voltage	26V
Temperature Range	−55°C ≤ T_A ≤ 125°C

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits. For specified specifications and test conditions, see the Electrical Characteristics. The ensured specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

Table 1. Quality Conformance Inspection Mil-Std-883, Method 5005 - Group A

Subgroup	Description	Temp °C
1	Static tests at	+25
2	Static tests at	+125
3	Static tests at	-55
4	Dynamic tests at	+25
5	Dynamic tests at	+125
6	Dynamic tests at	-55
7	Functional tests at	+25
8A	Functional tests at	+125
8B	Functional tests at	-55
9	Switching tests at	+25
10	Switching tests at	+125
11	Switching tests at	-55
12	Settling time at	+25
13	Settling time at	+125
14	Settling time at	-55

LM2940-5.0 Electrical Characteristics SMD: 5962R8958701 DC Parameters

The following conditions apply, unless otherwise specified.
DC: V_I = 10V, I_O = 1A, C_O = 22µF

Symbol	Parameter	Conditions	Notes	Min	Max	Unit	Sub-groups
V_O	Output Voltage	V_{IN} = 10V, I_{OUT} = 5mA		4.85	5.15	V	1
				4.75	5.25	V	2, 3
		V_{IN} = 6V, I_{OUT} = 5mA		4.85	5.15	V	1
				4.75	5.25	V	2, 3
		V_{IN} = 7V, I_{OUT} = 5mA		4.85	5.15	V	1
				4.75	5.25	V	2, 3
		V_{IN} = 26V, I_{OUT} = 5mA		4.85	5.15	V	1
				4.75	5.25	V	2, 3
		V_{IN} = 10V, I_{OUT} = 1A		4.85	5.15	V	1
				4.75	5.25	V	2, 3
		V_{IN} = 6V, I_{OUT} = 1A		4.85	5.15	V	1
				4.75	5.25	V	2, 3
		V_{IN} = 6V, I_{OUT} = 50mA		4.85	5.15	V	1
				4.75	5.25	V	2, 3
		V_{IN} = 10V, I_{OUT} = 50mA		4.85	5.15	V	1
				4.75	5.25	V	2, 3
	Reverse Polarity Input Voltage DC	R_O = 100Ω	See[1]	-15		V	1, 2, 3
I_Q	Quiescent Current	V_{IN} = 10V, I_{OUT} = 5mA		0.0	15	mA	1
				0.0	20	mA	2, 3
		V_{IN} = 7V, I_{OUT} = 5mA		0.0	15	mA	1
				0.0	20	mA	2, 3
		V_{IN} = 26V, I_{OUT} = 5mA		0.0	15	mA	1
				0.0	20	mA	2, 3
		V_{IN} = 10V, I_{OUT} = 1A		0.0	50	mA	1
				0.0	100	mA	2, 3

(1) Functional test only.

Product Folder Links: *LM2940QML LM2940QML-SP*

LM2940-5.0 Electrical Characteristics SMD: 5962R8958701 DC Parameters (continued)

The following conditions apply, unless otherwise specified.
DC: V_I = 10V, I_O = 1A, C_O = 22µF

Symbol	Parameter	Conditions	Notes	Min	Max	Unit	Sub-groups
V_{RLine}	Line Regulation	7V ≤ V_{IN} ≤ 26V, I_{OUT} = 5mA		-40	40	mV	1
				-50	50	mV	2, 3
V_{RLoad}	Load Regulation	V_{IN} = 10V, 50mA ≤ I_{OUT} ≤ 1A		-50	50	mV	1
				-100	100	mV	2, 3
V_{DO}	Dropout Voltage	I_{OUT} = 1A		0.0	0.7	V	1
				0.0	1.0	V	2, 3
		I_{OUT} = 100mA		0.0	200	mV	1
				0.0	300	mV	2, 3
I_{SC}	Short Circuit Current	V_{IN} = 10V		1.5		A	1
				1.3		A	2, 3

LM2940-5.0 Electrical Characteristics SMD: 5962R8958701 AC Parameters

The following conditions apply, unless otherwise specified.
AC: V_I = 10V, I_O = 1A, C_O = 22µF

Symbol	Parameter	Conditions	Notes	Min	Max	Unit	Sub-groups
	Max Line Transient	V_O ≤ 6V, R_O = 100Ω, t = 20mS	See[1]	40		V	1, 2, 3
	Reverse Polarity Input Voltage Transient	t = 20mS, R_O = 100Ω	See[1]	-45		V	1, 2, 3
RR	Ripple Rejection	V_{IN} = 10V, 1V_{RMS}, f = 1KHz, I_{OUT} = 5mA	See[1]	60		dB	4
			See[1]	50		dB	5, 6
N_O	Output Noise Voltage	V_{IN} = 10V, I_{OUT} = 5mA, 10Hz - 100KHz	See[1]	0.0	700	µV_{RMS}	1, 2, 3
Z_O	Output Impedance	V_{IN} = 10V, f_O = 120Hz I_{OUT} = 100mA DC and 20mA AC	See[1]		1.0	Ω	1, 2, 3

(1)   Functional test only.

LM2940-5.0 Electrical Characteristics SMD: 5962R8958702 DC Parameters

The following conditions apply, unless otherwise specified.

DC: V_I = 10V, I_O = 1A, C_O = 22µF

Symbol	Parameter	Conditions	Notes	Min	Max	Unit	Sub-groups
V_O	Output Voltage	V_{IN} = 10V, I_{OUT} = 5mA		4.85	5.15	V	1
				4.75	5.25	V	2, 3
		V_{IN} = 6V, I_{OUT} = 5mA		4.85	5.15	V	1
				4.75	5.25	V	2, 3
		V_{IN} = 7V, I_{OUT} = 5mA		4.85	5.15	V	1
				4.75	5.25	V	2, 3
		V_{IN} = 26V, I_{OUT} = 5mA		4.85	5.15	V	1
				4.75	5.25	V	2, 3
		V_{IN} = 10V, I_{OUT} = 1A		4.85	5.15	V	1
				4.75	5.25	V	2, 3
		V_{IN} = 6V, I_{OUT} = 1A		4.85	5.15	V	1
				4.75	5.25	V	2, 3
		V_{IN} = 6V, I_{OUT} = 50mA		4.85	5.15	V	1
				4.75	5.25	V	2, 3
		V_{IN} = 10V, I_{OUT} = 50mA		4.85	5.15	V	1
				4.75	5.25	V	2, 3
	Reverse Polarity Input Voltage DC	R_O = 100Ω	See[1]	-15		V	1, 2, 3
I_Q	Quiescent Current	V_{IN} = 10V, I_{OUT} = 5mA		0.0	15	mA	1
				0.0	20	mA	2, 3
		V_{IN} = 7V, I_{OUT} = 5mA		0.0	15	mA	1
				0.0	20	mA	2, 3
		V_{IN} = 26V, I_{OUT} = 5mA		0.0	15	mA	1
				0.0	20	mA	2, 3
		V_{IN} = 10V, I_{OUT} = 1A		0.0	50	mA	1
				0.0	100	mA	2, 3
V_{RLine}	Line Regulation	7V ≤ V_{IN} ≤ 26V, I_{OUT} = 5mA		-40	40	mV	1
				-50	50	mV	2, 3
V_{RLoad}	Load Regulation	V_{IN} = 10V, 50mA ≤ I_{OUT} ≤ 1A		-50	50	mV	1
				-100	100	mV	2, 3
V_{DO}	Dropout Voltage	I_{OUT} = 1A		0.0	0.7	V	1
				0.0	1.0	V	2, 3
		I_{OUT} = 100mA		0.0	200	mV	1
				0.0	300	mV	2, 3
I_{SC}	Short Circuit Current	V_{IN} = 10V		1.5		A	1
				1.3		A	2, 3

(1) Functional test only.

Product Folder Links: *LM2940QML LM2940QML-SP*

LM2940-5.0 Electrical Characteristics SMD: 5962R8958702 AC Parameters

The following conditions apply, unless otherwise specified.
AC: V_I = 10V, I_O = 1A, C_O = 22µF

Symbol	Parameter	Conditions	Notes	Min	Max	Unit	Sub-groups
	Max Line Transient	V_O ≤ 6V, R_O = 100Ω, t = 20mS	See[1]	40		V	1, 2, 3
	Reverse Polarity Input Voltage Transient	t = 20mS, R_O = 100Ω	See[1]	-45		V	1, 2, 3
RR	Ripple Rejection	V_{IN} = 10V, $1V_{RMS}$, f = 1KHz, I_{OUT} = 5mA	See[1]	60		dB	4
			See[1]	50		dB	5, 6
N_O	Output Noise Voltage	V_{IN} = 10V, I_{OUT} = 5mA, 10Hz - 100KHz	See[1]	0.0	700	μV_{RMS}	1, 2, 3
Z_O	Output Impedance	V_{IN} = 10V, f_O = 120Hz I_{OUT} = 100mA DC and 20mA AC	See[1]		1.0	Ω	1, 2, 3

(1)   Functional test only.

LM2940-5.0 Electrical Characteristics SMD: 5962R8958702 DC Drift Parameters

The following conditions apply, unless otherwise specified.
DC: V_I = 10V, I_O = 1A, C_O = 22µF, **"Delta calculations performed on QMLV devices at group B, subgroup 5 only"**

Symbol	Parameter	Conditions	Notes	Min	Max	Unit	Sub-groups
V_O	Output Voltage	V_{IN} = 10V, I_{OUT} = 5mA		-30	30	mV	1
		V_{IN} = 6V, I_{OUT} = 5mA		-30	30	mV	1
		V_{IN} = 7V, I_{OUT} = 5mA		-30	30	mV	1
		V_{IN} = 26V, I_{OUT} = 5mA		-30	30	mV	1
		V_{IN} = 10V, I_{OUT} = 1A		-30	30	mV	1
		V_{IN} = 6V, I_{OUT} = 1A		-30	30	mV	1
		V_{IN} = 6V, I_{OUT} = 50mA		-30	30	mV	1
		V_{IN} = 10V, I_{OUT} = 50mA		-30	30	mV	1
V_{RLOAD}	Load Regulation	V_{IN} = 10V, 50mA ≤ I_{OUT} ≤ 1A		-20	20	mV	1

Typical Performance Characteristics
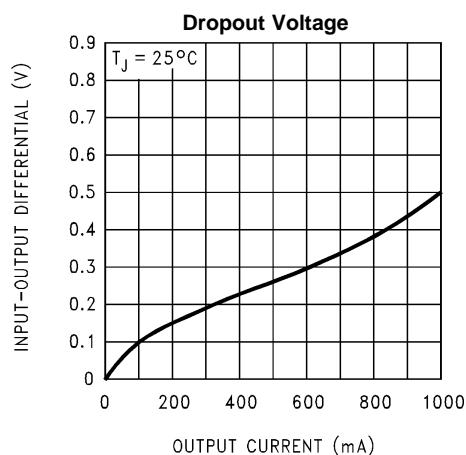
Figure 2. Dropout Voltage
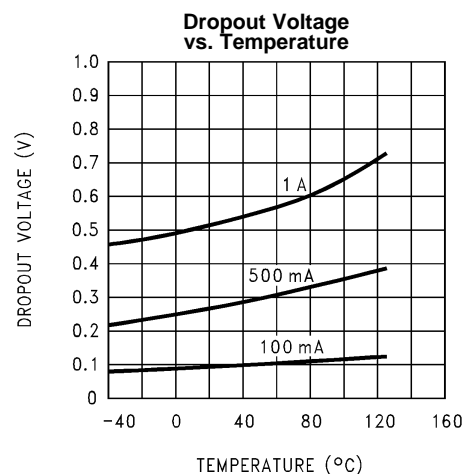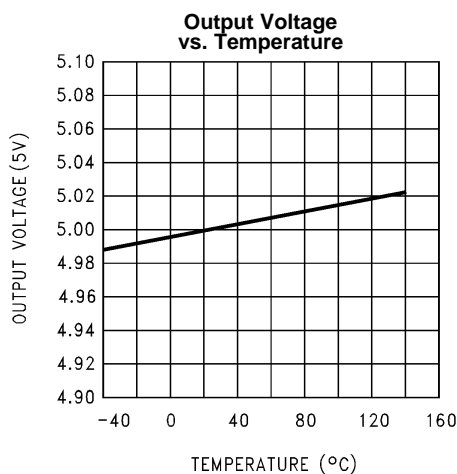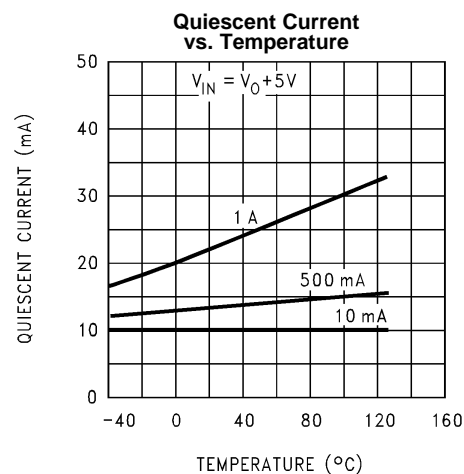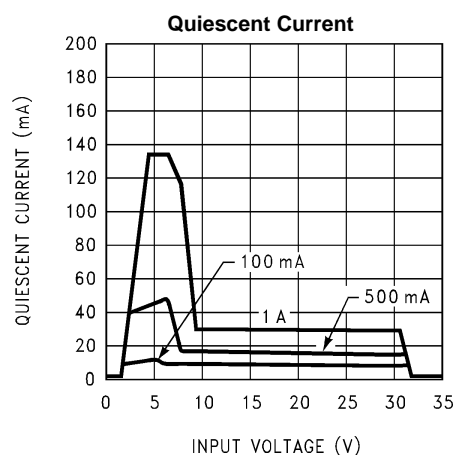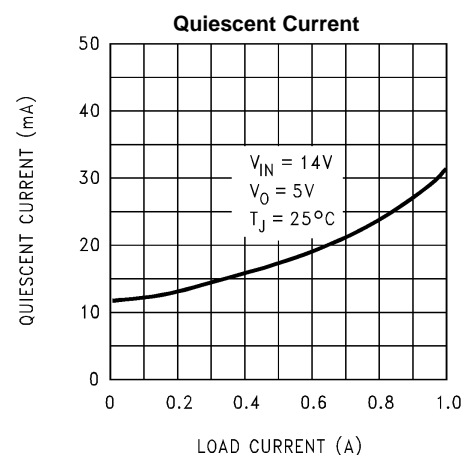
Figure 3. Dropout Voltage vs. Temperature

Figure 4. Output Voltage vs. Temperature

Figure 5. Quiescent Current vs. Temperature

Figure 6. Quiescent Current

Figure 7. Quiescent Current

Typical Performance Characteristics (continued)

Line Transient Response

Figure 8.

Load Transient Response

Figure 9.

Ripple Rejection

Figure 10.

Low Voltage Behavior

Figure 11.

Low Voltage Behavior

Figure 12.

Low Voltage Behavior
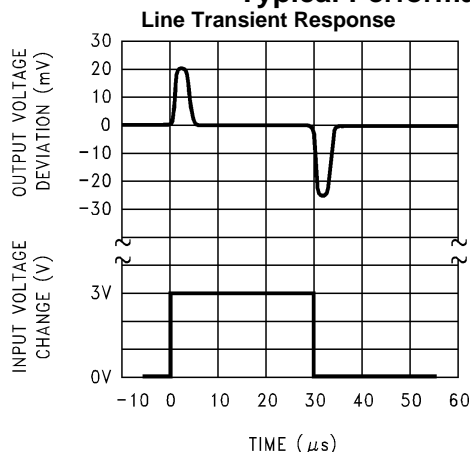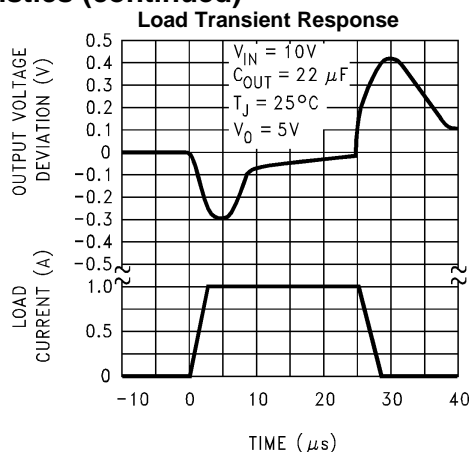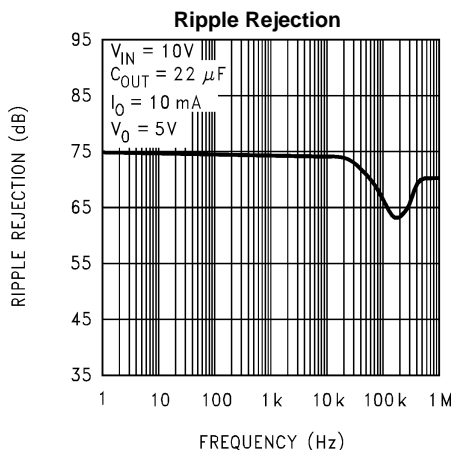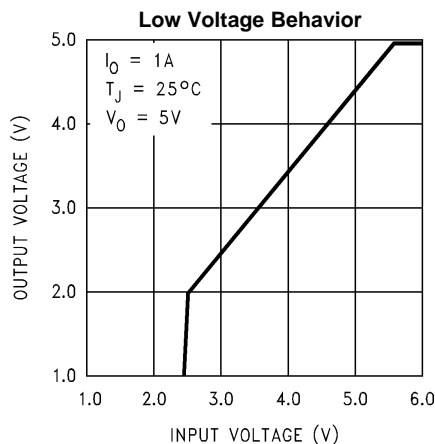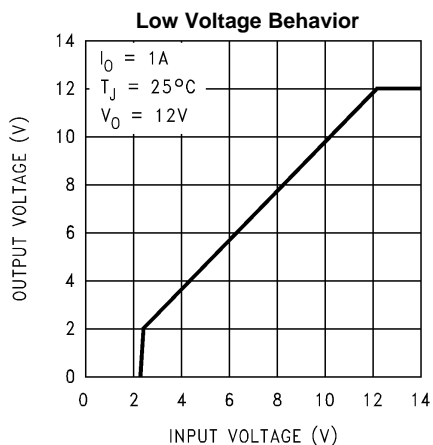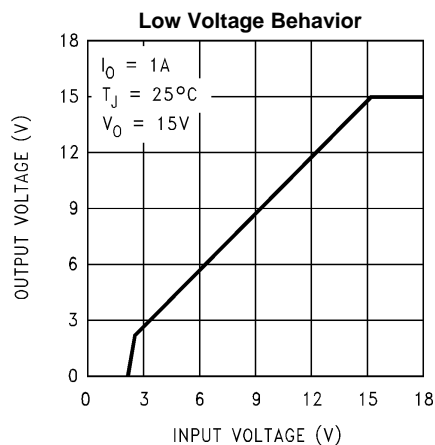
Figure 13.

Typical Performance Characteristics (continued)

Output at Voltage Extremes

Figure 14.

Output at Voltage Extremes

Figure 15.

Output at Voltage Extremes

Figure 16.

Output Capacitor ESR

Figure 17.

Peak Output Current

Figure 18.

Output Impedance

Figure 19.

Product Folder Links: *LM2940QML LM2940QML-SP*
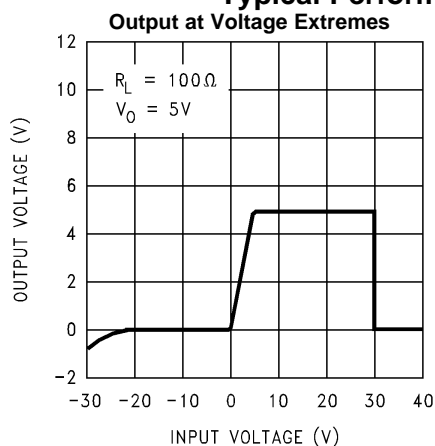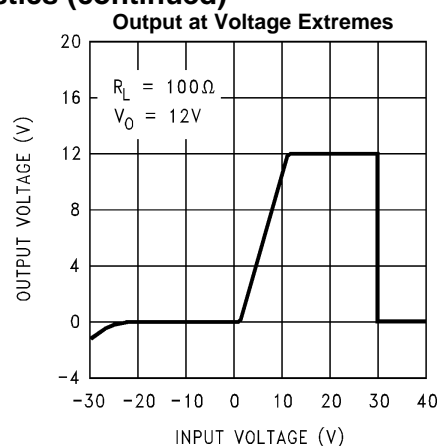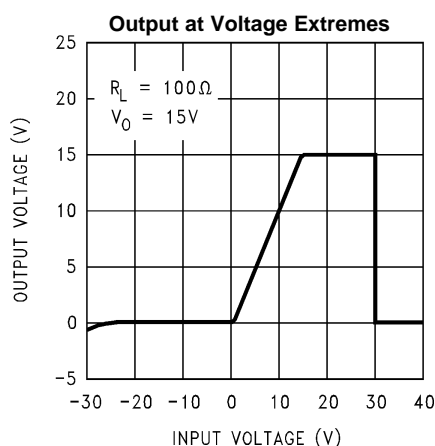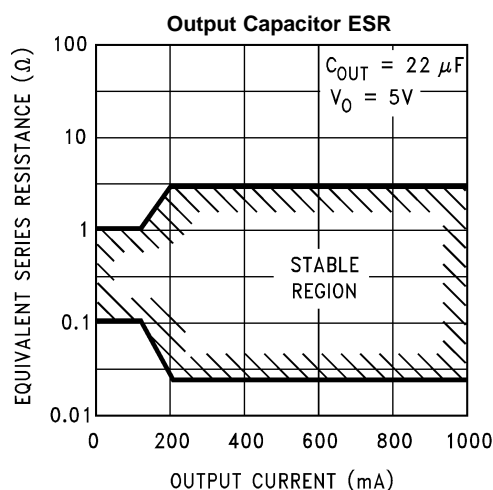
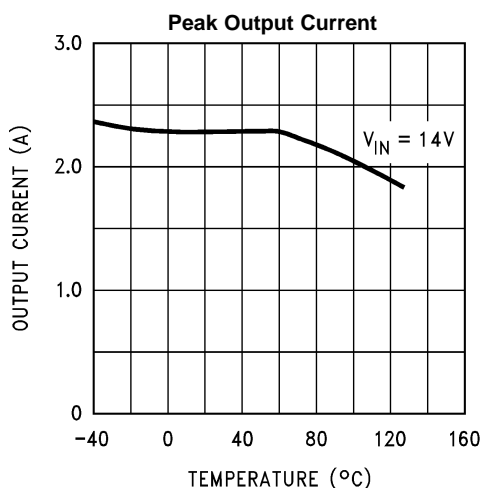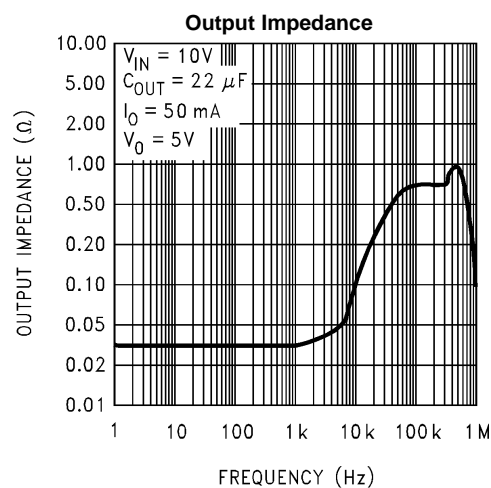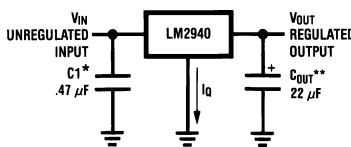## Typical Application

*Required if regulator is located far from power supply filter.

**C_{OUT} must be at least 22 μF to maintain stability. May be increased without bound to maintain regulation during transients. Locate as close as possible to the regulator. This capacitor must be rated over the same operating temperature range as the regulator and the ESR is critical; see curve.

APPLICATION HINTS

EXTERNAL CAPACITORS

The output capacitor is critical to maintaining regulator stability, and must meet the required conditions for both ESR (Equivalent Series Resistance) and minimum amount of capacitance.

MINIMUM CAPACITANCE:

The minimum output capacitance required to maintain stability is 22 μF (this value may be increased without limit). Larger values of output capacitance will give improved transient response.

ESR LIMITS:

The ESR of the output capacitor will cause loop instability if it is too high or too low. The acceptable range of ESR plotted versus load current is shown in the graph below. **It is essential that the output capacitor meet these requirements, or oscillations can result.**
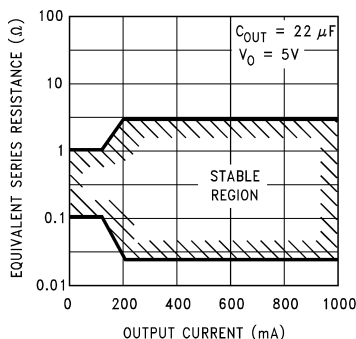

Figure 20. Output Capacitor ESR Limits

It is important to note that for most capacitors, ESR is specified only at room temperature. However, the designer must ensure that the ESR will stay inside the limits shown over the entire operating temperature range for the design.

For aluminum electrolytic capacitors, ESR will increase by about 30X as the temperature is reduced from 25°C to −40°C. This type of capacitor is not well-suited for low temperature operation.

Solid tantalum capacitors have a more stable ESR over temperature, but are more expensive than aluminum electrolytics. A cost-effective approach sometimes used is to parallel an aluminum electrolytic with a solid Tantalum, with the total capacitance split about 75/25% with the Aluminum being the larger value.

If two capacitors are paralleled, the effective ESR is the parallel of the two individual values. The "flatter" ESR of the Tantalum will keep the effective ESR from rising as quickly at low temperatures.

HEATSINKING

A heatsink may be required depending on the maximum power dissipation and maximum ambient temperature of the application. Under all possible operating conditions, the junction temperature must be within the range specified under Absolute Maximum Ratings.

To determine if a heatsink is required, the power dissipated by the regulator, P_D, must be calculated.

The figure below shows the voltages and currents which are present in the circuit, as well as the formula for calculating the power dissipated in the regulator:
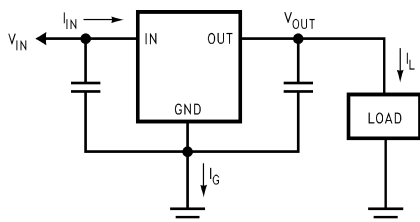
$I_{IN} = I_L \div I_G$

$P_D = (V_{IN} - V_{OUT}) I_L + (V_{IN}) I_G$

Figure 21. Power Dissipation Diagram

The next parameter which must be calculated is the maximum allowable temperature rise, T_R (max). This is calculated by using the formula:

T_R (max) = T_J(max) − T_A (max)

where

- T_J (max) is the maximum allowable junction temperature
- T_A (max) is the maximum ambient temperature which will be encountered in the application   (1)

Using the calculated values for T_R(max) and P_D, the maximum allowable value for the junction-to-ambient thermal resistance, $\theta_{(JA)}$, can now be found:

$\theta_{(JA)} = T_R$ (max)/P_D (2)

REVISION HISTORY

Released	Revision	Section	Changes
05/10/2010	A	New Release, Corporate format	1 MDS data sheets converted into one Corp. data sheet format added reference to New ELDRS device. Change AC subgroups from 4, 5, 6, 7, 8A, 8B to 1, 2, 3 for parameters Max Line Transient, Reverse Polarity Input Voltage Transient, Output Noise Voltage, Output Impedance. To bring it into agreement with the SMD. MNLM2940-5.0-X Rev 1A1 will be archived.
12/10/2010	B	Ordering Information, Absolute Max Ratings	Ordering Information — Added LM2940GW5.0/883, LM2940GW5.0RLQV. Absolute Max Ratings — Added Theta JA and Theta JC along with Package Weight for 'GW' devices. LM2940QML Rev A will be archived.
02/5/2013	B	All	layout of National Data Sheet to TI format

PACKAGE OPTION ADDENDUM

PACKAGING INFORMATION

Orderable part number (1)	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
5962-8958703XA	Active	Production	CFP (NAC) | 16	88 | TUBE	No	SNPB	Level-1-NA-UNLIM	-55 to 125	LM2940GW5.0 /883 Q 5962-89587 03XA ACO 03XA >T
5962R8958702V9A	Active	Production	DIESALE (Y) | 0	34 | NOT REQUIRED	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	
5962R8958704VXA	Active	Production	CFP (NAC) | 16	88 | JEDEC TRAY (5+1)	No	SNPB	Level-1-NA-UNLIM	-55 to 125	LM2940GW5.0 RLQMLV Q 5962R89587 04VXA ACO 04VXA >T
LM2940-5.0 MDE	Active	Production	DIESALE (Y) | 0	34 | NOT REQUIRED	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	
LM2940-5.0-MW8	Active	Production	WAFERSALE (YS) | 0	1 | NOT REQUIRED	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	
LM2940GW5.0/883	Active	Production	CFP (NAC) | 16	88 | TUBE	No	SNPB	Level-1-NA-UNLIM	-55 to 125	LM2940GW5.0 /883 Q 5962-89587 03XA ACO 03XA >T
LM2940GW5.0RLQV	Active	Production	CFP (NAC) | 16	88 | JEDEC TRAY (5+1)	No	SNPB	Level-1-NA-UNLIM	-55 to 125	LM2940GW5.0 RLQMLV Q 5962R89587 04VXA ACO 04VXA >T

(1) Status: For more details on status, see our product life cycle.

(2) Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

(4) Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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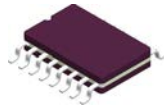
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF LM2940QML, LM2940QML-SP :

● Military : LM2940QML

● Space : LM2940QML-SP

NOTE: Qualified Version Definitions:

> ● Military - QML certified for Military and Defense Applications

> ● Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application
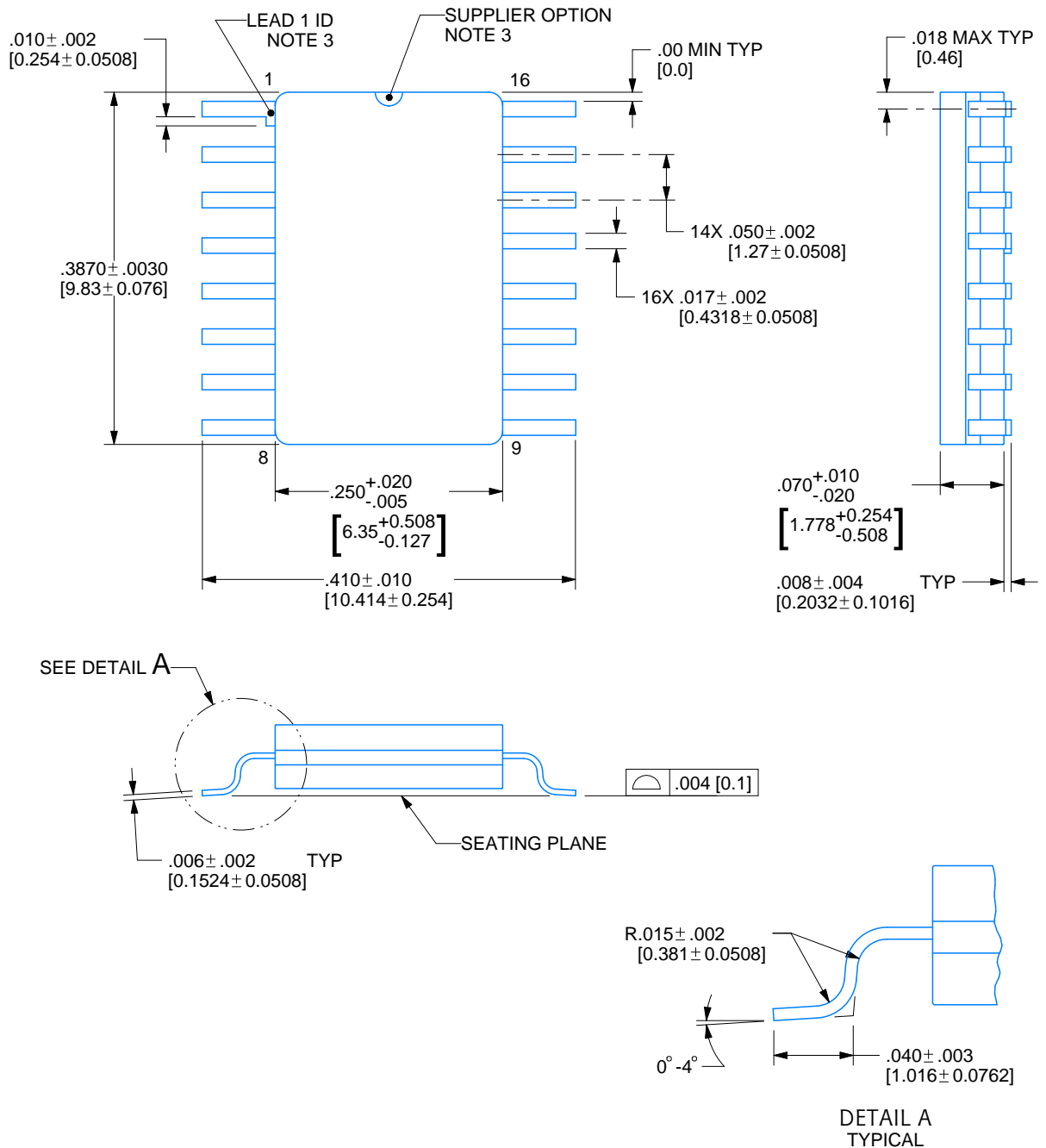
NAC0016A

LEAD 1 ID
NOTE 3

SUPPLIER OPTION
NOTE 3

.010± .002
[0.254± 0.0508]

.00 MIN TYP
[0.0]

.018 MAX TYP
[0.46]

1

16

.3870± .0030
[9.83± 0.076]

14X .050± .002
[1.27± 0.0508]

16X .017± .002
[0.4318± 0.0508]

8

9

$.250^{+.020}_{-.005}$

$\left[6.35^{+0.508}_{-0.127}\right]$

.410± .010
[10.414± 0.254]

$.070^{+.010}_{-.020}$

$\left[1.778^{+0.254}_{-0.508}\right]$

.008± .004
[0.2032± 0.1016]

TYP

SEE DETAIL A

.004 [0.1]

SEATING PLANE

.006± .002   TYP
[0.1524± 0.0508]

R.015± .002
[0.381± 0.0508]

0° -4°

.040± .003
[1.016± 0.0762]

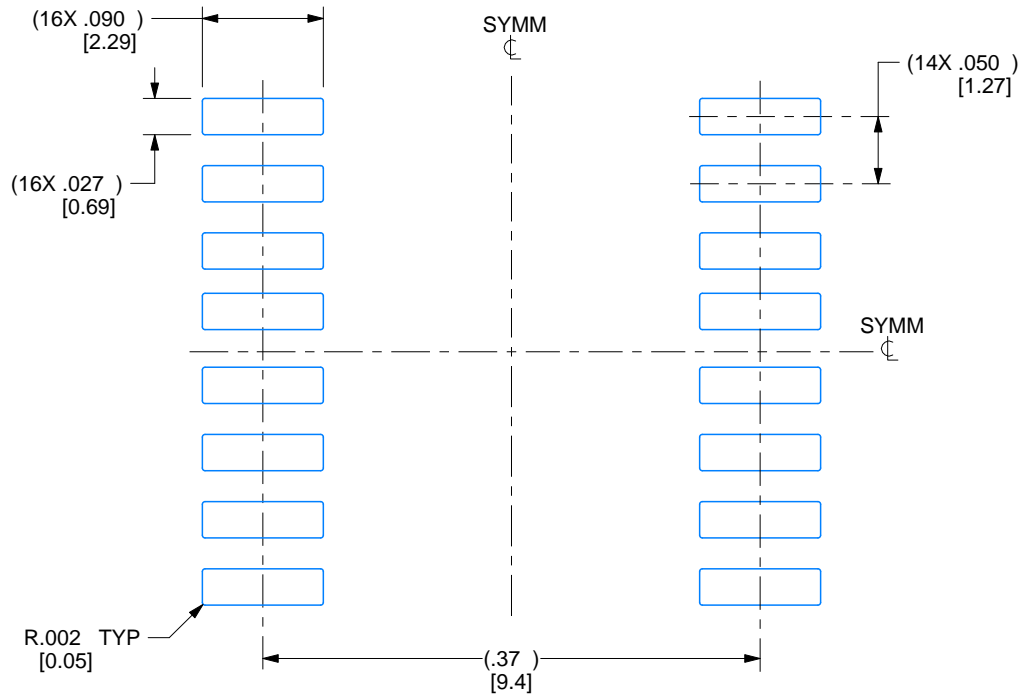**DETAIL A**
TYPICAL

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NOTES:

1. Controlling dimension is Inch.   Values in [ ] are milimeters. Dimensions in ( ) for reference only.
2. For solder thickness and composition, see the "Lead Finish Composition/Thickness" link in the packaging section of the
    Texas Instruments website
3. Lead 1 identification shall be:
    a) A notch or other mark within this area
    b) A tab on lead 1, either side
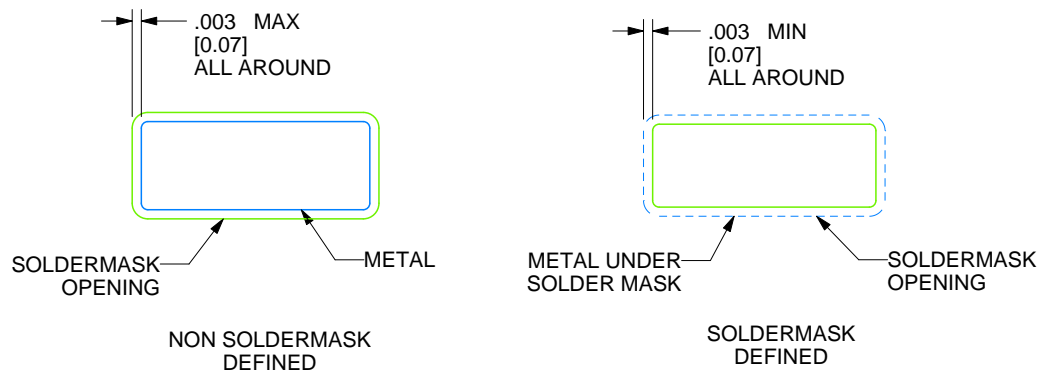4. No JEDEC registration as of December 2021

TEXAS INSTRUMENTS
www.ti.com

NAC0016A

(16X .090)
[2.29]

SYMM
℄

(14X .050)
[1.27]

(16X .027)
[0.69]

SYMM
℄

R.002 TYP
[0.05]

(.37)
[9.4]

RECOMMENDED LAND PATTERN

.003 MAX
[0.07]
ALL AROUND

.003 MIN
[0.07]
ALL AROUND

SOLDERMASK
OPENING

METAL

METAL UNDER
SOLDER MASK

SOLDERMASK
OPENING

NON SOLDERMASK
DEFINED

SOLDERMASK
DEFINED

4215198/C 08/2022

REVISIONS				
REV	DESCRIPTION	E.C.N.	DATE	BY/APP'D
A	RELEASE TO DOCUMENT CONTROL	2197879	12/30/2021	TINA TRAN / ANIS FAUZI
B	NO CHANGE TO DRAWING; REVISION FOR YODA RELEASE;	2198832	02/15/2022	K. SINCERBOX
C	.387± .003 WAS .39000± .00012;	2200917	08/08/2022	D. CHIN / K. SINCERBOX

SCALE	SIZE		REV	PAGE
	A	4215198	C	4 OF 4

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